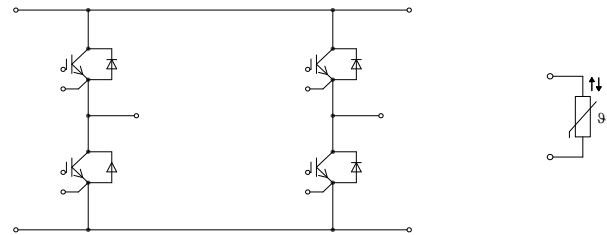
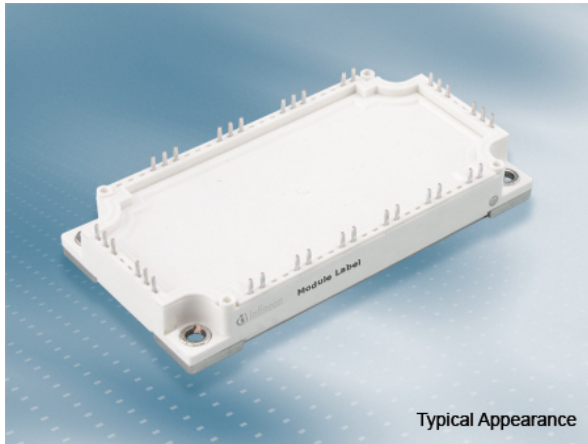


EconoPACK™3 Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled Diode und NTC
 EconoPACK™3 module with Trench/Fieldstop IGBT4 and Emitter Controlled diode and NTC



$V_{CES} = 1700V$
 $I_{C\ nom} = 100A / I_{CRM} = 200A$

Potentielle Anwendungen

- Hochleistungsumrichter
- Mittelspannungsantriebe

Elektrische Eigenschaften

- Niedriges V_{CEsat}
- $T_{vj\ op} = 150^{\circ}C$
- Trench IGBT 4
- V_{CEsat} mit positivem Temperaturkoeffizienten

Mechanische Eigenschaften

- Integrierter NTC Temperatur Sensor
- Isolierte Bodenplatte
- Lötverbindungstechnik
- Standardgehäuse

Potential Applications

- High power converters
- Medium voltage converters

Electrical Features

- Low V_{CEsat}
- $T_{vj\ op} = 150^{\circ}C$
- Trench IGBT 4
- V_{CEsat} with positive temperature coefficient

Mechanical Features

- Integrated NTC temperature sensor
- Isolated base plate
- Solder contact technology
- Standard housing

Module Label Code

Barcode Code 128



DMX - Code



Content of the Code

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

IGBT, Wechselrichter / IGBT, Inverter

Höchstzulässige Werte / Maximum Rated Values

Kollektor-Emitter-Sperrspannung Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1700	V
Kollektor-Dauergleichstrom Continuous DC collector current	$T_C = 100^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$	I_{CDC}	100	A
Periodischer Kollektor-Spitzenstrom Repetitive peak collector current	$t_P = 1\text{ ms}$	I_{CRM}	200	A
Gate-Emitter-Spitzenspannung Gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte / Characteristic Values

			min.	typ.	max.		
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage	$I_C = 100\text{ A}$ $V_{GE} = 15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_{CE\text{ sat}}$	1,95 2,35 2,45	2,30	V V V	
Gate-Schwellenspannung Gate threshold voltage	$I_C = 4,00\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		V_{GEth}	5,35	5,80	6,25	V
Gateladung Gate charge	$V_{GE} = -15 / 15\text{ V}$		Q_G	1,20			μC
Interner Gatewiderstand Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		R_{Gint}	7,5			Ω
Eingangskapazität Input capacitance	$f = 1000\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{ies}	9,00			nF
Rückwirkungskapazität Reverse transfer capacitance	$f = 1000\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{res}	0,29			nF
Kollektor-Emitter-Reststrom Collector-emitter cut-off current	$V_{CE} = 1700\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$		I_{CES}			1,0	mA
Gate-Emitter-Reststrom Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}			400	nA
Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Gon} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{don}	0,201 0,22 0,23			μs μs μs
Anstiegszeit, induktive Last Rise time, inductive load	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Gon} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_r	0,032 0,04 0,041			μs μs μs
Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Goff} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{doff}	0,416 0,564 0,60			μs μs μs
Fallzeit, induktive Last Fall time, inductive load	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Goff} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_f	0,281 0,508 0,588			μs μs μs
Einschaltverlustenergie pro Puls Turn-on energy loss per pulse	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}, L\sigma = 35\text{ nH}$ $di/dt = 2900\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $V_{GE} = -15 / 15\text{ V}, R_{Gon} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{on}	19,4 26,7 29,1			mJ mJ mJ
Abschaltverlustenergie pro Puls Turn-off energy loss per pulse	$I_C = 100\text{ A}, V_{CE} = 900\text{ V}, L\sigma = 35\text{ nH}$ $du/dt = 3200\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $V_{GE} = -15 / 15\text{ V}, R_{Goff} = 0,91\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{off}	17,7 29,7 34,1			mJ mJ mJ
Kurzschlußverhalten SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 1000\text{ V}$ $V_{CE\max} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$		I_{SC}	460			A
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro IGBT / per IGBT		R_{thJC}			0,256	K/W
Wärmewiderstand, Gehäuse bis Kühlkörper Thermal resistance, case to heatsink	pro IGBT / per IGBT $\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}			0,128	K/W
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj\text{ op}}$	-40		150	$^{\circ}\text{C}$